



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
STEPHEN KEETAI PARK

Serial No.: 10/045,895

Filed: October 29, 2001

For: METHOD OF FABRICATING  
COPPER-BASED SEMICONDUCTOR  
DEVICES USING A SACRIFICIAL  
DIELECTRIC LAYER

Examiner: Hsien-Ming Lee

Group Art Unit: 2823

Att'y Docket: 2000.029996/TT3586C

RECEIVED  
JUN 11 2003  
TECHNOLOGY CENTER 2800

RESPONSE TO OFFICE ACTION DATED MAY 2, 2003

CERTIFICATE OF MAILING  
37 C.F.R 1.8

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop: Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:

06/03/03

Date

*Kathy Moran*

Signature

Mail Stop: Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This paper is submitted in response to the Office Action dated May 2, 2003, for which the three-month date for response is August 2, 2003.

It is believed that no fee is due; however, should any fees under 37 C.F.R. §§ 1.16 to 1.21 be required for any reason, the Assistant Commissioner is authorized to deduct said fees from Advanced Micro Devices, Inc.'s Deposit Account 01-0365/TT3658C.

Reconsideration of the application is respectfully requested.